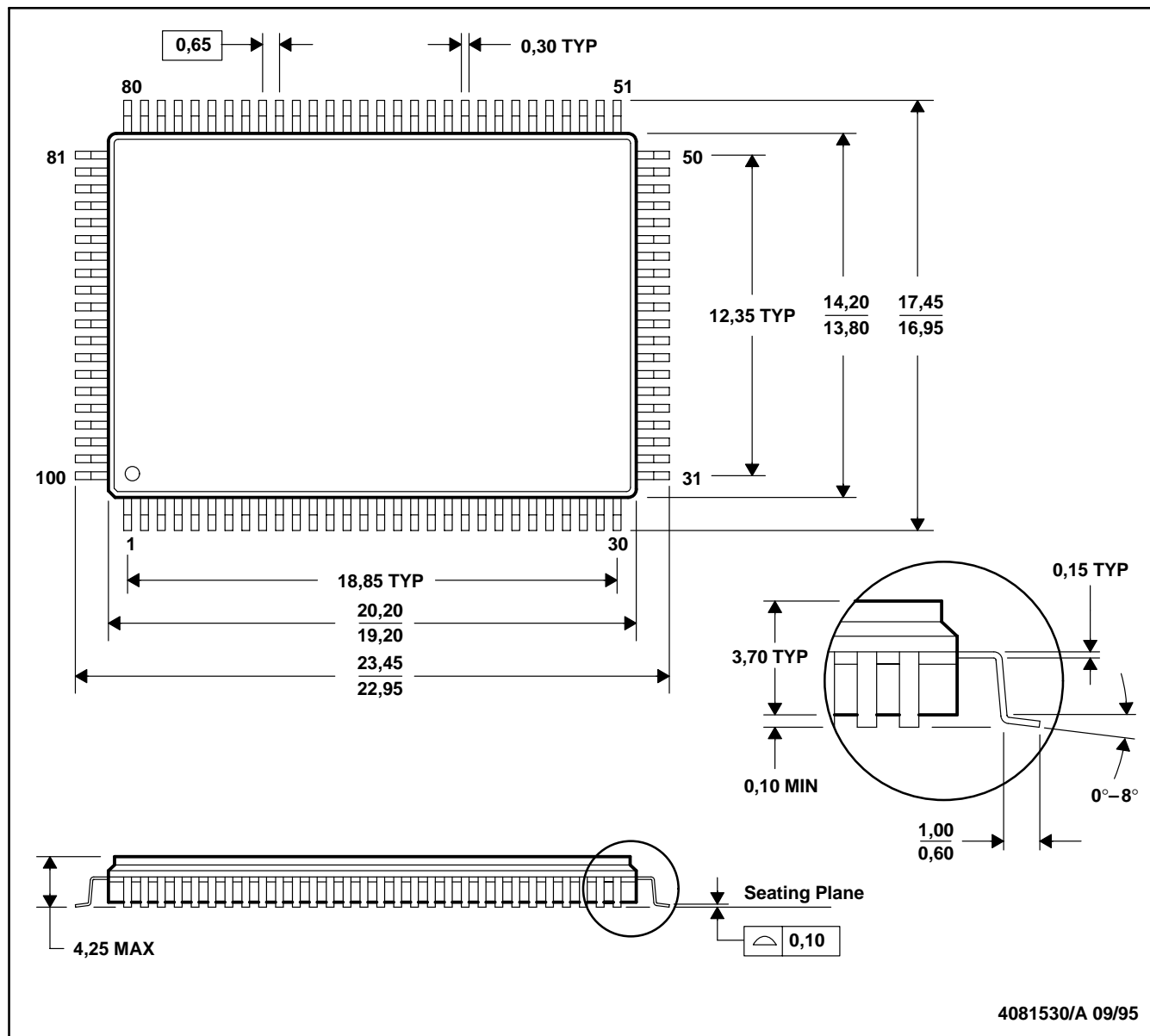


## HFD (S-GQFP-G100)

## CERAMIC QUAD FLATPACK



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.

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